



# BFR720L3RH

Low Noise Silicon Germanium Bipolar RF Transistor

## Data Sheet

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RF & Protection Devices

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**Revision History: 2012-09-03, Version 2**

Page	Subjects (major changes since last revision)
	This data sheet replaces the revision from 2008-07-04. The production processes have not been changed and the typical device properties remain the same. Only the product description has been expanded and the characteristic curves taken with another test setup.

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## 1 Product Brief

The BFR720L3RH is a very low noise wideband NPN RF transistor. The device is based on Infineon's reliable high volume silicon germanium carbon (SiGe:C) heterojunction bipolar technology. The BFR720L3RH provides a transition frequency  $f_T$  of 43 GHz and is suited for low voltage applications ( $V_{CEO,max} = 4$  V) from VHF to 12 GHz. Due to its low power consumption the device is very energy efficient and well suited for mobile applications. The BFR720L3RH is housed in a very thin small leadless package ideal for modules.

## 2 Features

- Very low noise figure  $NF_{min} = 0.45$  dB at 1.9 GHz, 0.65 dB at 5.5 GHz, 3 V, 4 mA
- High power gain  $G_{ms} = 21$  dB at 5.5 GHz, 13 mA, 3 V
- Very thin small leadless package (height only 0.31 mm), hence ideal for modules with compact size and low profile height
- Pb-free (RoHS compliant) and halogen-free package
- Qualification report according to AEC-Q101 available



TSLP-3-9



## 3 Applications

As Low Noise Amplifier (LNA) in

- Mobile, portable and fixed connectivity applications: WLAN 802.11a/b/g/n, WiMAX 2.5/3.5/5 GHz, UWB, Bluetooth
- Satellite communication systems: Navigation systems (GPS, Glonass), satellite radio (SDARs, DAB) and C-band LNB
- Multimedia applications such as mobile/portable TV, CATV, FM Radio
- 3G/4G UMTS/LTE mobile phone applications
- ISM applications like RKE, AMR and Zigbee, as well as for emerging wireless applications

As discrete active mixer, amplifier in VCOs and buffer amplifier

***Attention: ESD (Electrostatic discharge) sensitive device, observe handling precautions***

## 4 Pin Configuration

Product Name	Package	Pin Configuration <sup>1)</sup>			Marking
BFR720L3RH	TSLP-3-9	1 = B	2 = C	3 = E	R3

1) See “[Package Information TSLP-3-9](#)” on Page 27

## Maximum Ratings

## 5 Maximum Ratings

**Table 5-1 Maximum Ratings at  $T_A = 25^\circ\text{C}$  (unless otherwise specified)**

Parameter	Symbol	Values		Unit	Note / Test Condition
		Min.	Max.		
Collector emitter voltage	$V_{CEO}$	—	4.0	V	Open base $T_A = 25^\circ\text{C}$ $T_A = -55^\circ\text{C}$
—		—	3.5		
Collector emitter voltage	$V_{CES}$	—	13	V	E-B short circuited
Collector base voltage	$V_{CBO}$	—	13	V	Open emitter
Emitter base voltage	$V_{EBO}$	—	1.2	V	Open collector
Collector current	$I_C$	—	30	mA	—
Base current	$I_B$	—	3	mA	—
Total power dissipation <sup>1)</sup>	$P_{tot}$	—	120	mW	$T_S \leq 103^\circ\text{C}$
Junction temperature	$T_J$	—	150	°C	—
Storage temperature	$T_{Stg}$	-55	150	°C	—

1)  $T_S$  is the soldering point temperature.  $T_S$  is measured on the emitter lead at the soldering point of the pcb.

**Attention: Stresses above the max. values listed here may cause permanent damage to the device.**

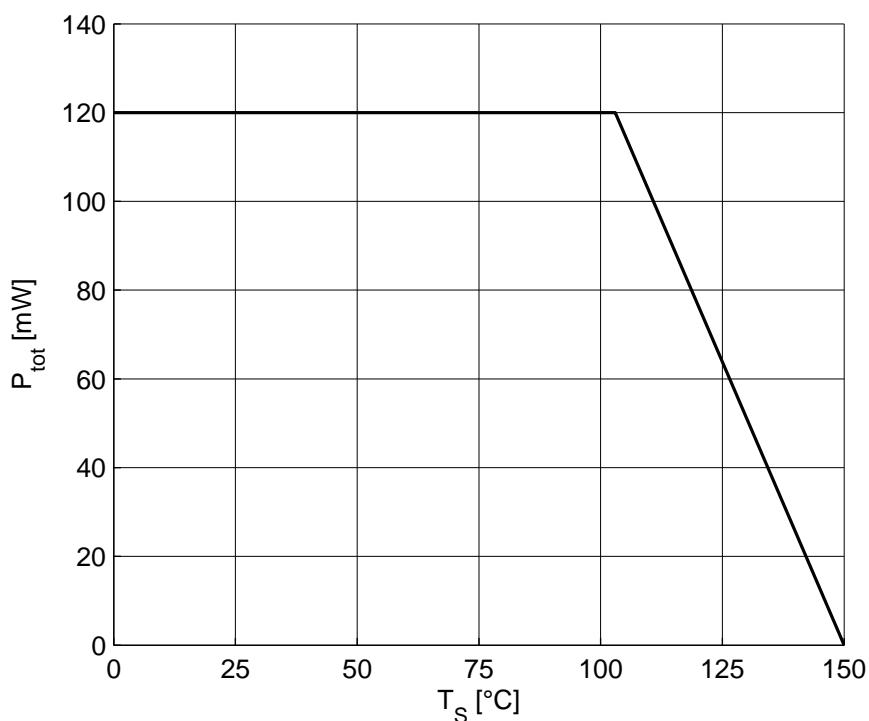
**Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Maximum ratings are absolute ratings; exceeding only one of these values may cause irreversible damage to the integrated circuit.**

## 6 Thermal Characteristics

**Table 6-1 Thermal Resistance**

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Junction - soldering point <sup>1)</sup>	$R_{thJS}$	—	390	—	K/W	—

1)For the definition of  $R_{thJS}$  please refer to Application Note AN077 (Thermal Resistance Calculation)



**Figure 6-1 Total Power Dissipation  $P_{tot} = f(T_S)$**

## 7 Electrical Characteristics

### 7.1 DC Characteristics

**Table 7-1 DC Characteristics at  $T_A = 25^\circ\text{C}$**

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Collector emitter breakdown voltage	$V_{(\text{BR})\text{CEO}}$	4	4.7	—	V	$I_C = 1 \text{ mA}, I_B = 0$ Open base
Collector emitter leakage current	$I_{\text{CES}}$	—	1 1	400 40	nA	$V_{\text{CE}} = 13 \text{ V}, V_{\text{BE}} = 0$ $V_{\text{CE}} = 5 \text{ V}, V_{\text{BE}} = 0$ E-B short circuited
Collector base leakage current	$I_{\text{CBO}}$	—	1	40	nA	$V_{\text{CB}} = 5 \text{ V}, I_E = 0$ Open emitter
Emitter base leakage current	$I_{\text{EBO}}$	—	1	40	nA	$V_{\text{EB}} = 0.5 \text{ V}, I_C = 0$ Open collector
DC current gain	$h_{\text{FE}}$	160	250	400		$V_{\text{CE}} = 3 \text{ V}, I_C = 13 \text{ mA}$ Pulse measured

### 7.2 General AC Characteristics

**Table 7-2 General AC Characteristics at  $T_A = 25^\circ\text{C}$**

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Transition frequency	$f_T$	—	43	—	GHz	$V_{\text{CE}} = 3 \text{ V}, I_C = 13 \text{ mA}$ $f = 2 \text{ GHz}$
Collector base capacitance	$C_{\text{CB}}$	—	0.07	0.10	pF	$V_{\text{CB}} = 3 \text{ V}, V_{\text{BE}} = 0$ $f = 1 \text{ MHz}$ Emitter grounded
Collector emitter capacitance	$C_{\text{CE}}$	—	0.26	—	pF	$V_{\text{CE}} = 3 \text{ V}, V_{\text{BE}} = 0$ $f = 1 \text{ MHz}$ Base grounded
Emitter base capacitance	$C_{\text{EB}}$	—	0.27	—	pF	$V_{\text{EB}} = 0.5 \text{ V}, V_{\text{CB}} = 0$ $f = 1 \text{ MHz}$ Collector grounded

### 7.3 Frequency Dependent AC Characteristics

Measurement setup is a test fixture with Bias T's in a  $50 \Omega$  system,  $T_A = 25^\circ\text{C}$ .

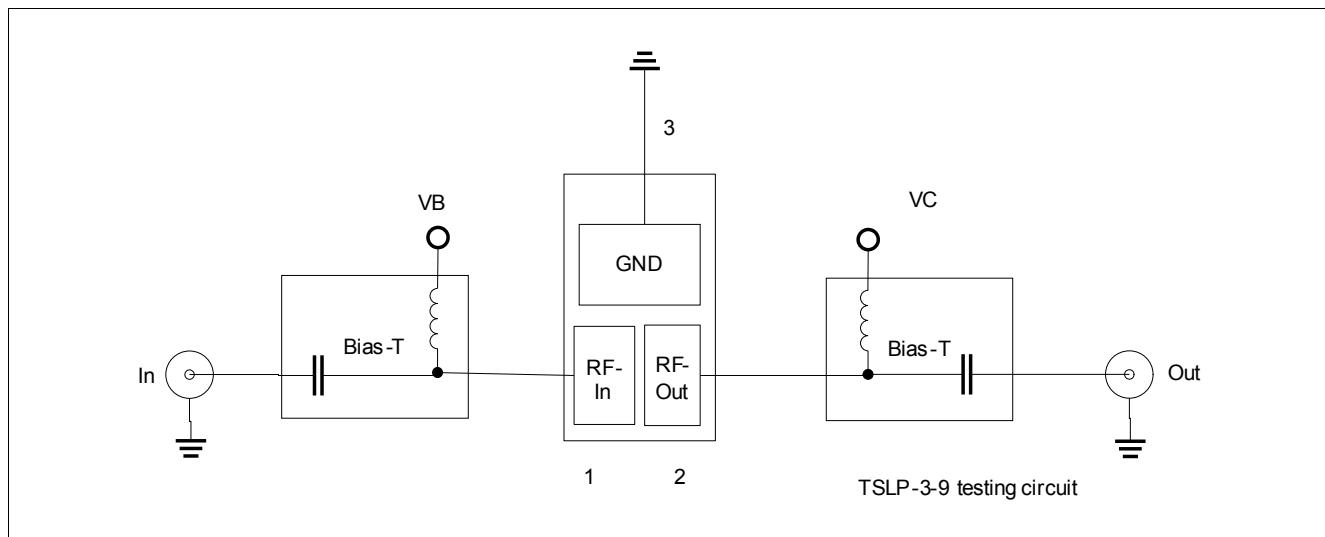


Figure 7-1 Testing Circuit

Table 7-3 AC Characteristics,  $V_{CE} = 3 \text{ V}, f = 150 \text{ MHz}$

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
<b>Power Gain</b>					dB	
Maximum power gain	$G_{ms}$	—	36.5	—		$I_C = 13 \text{ mA}$
Transducer gain	$ S_{21} ^2$	—	28	—		$I_C = 13 \text{ mA}$
<b>Minimum Noise Figure</b>					dB	
Minimum noise figure	$NF_{min}$	—	0.45	—		$I_C = 4 \text{ mA}$
Associated gain	$G_{ass}$	—	26.5	—		$I_C = 4 \text{ mA}$
<b>Linearity</b>					dBm	
1 dB compression point at output	$OP_{1dB}$	—	5.5	—		$Z_S = Z_L = 50 \Omega$
3rd order intercept point at output	$OIP_3$	—	19.5	—		$I_C = 13 \text{ mA}$

Table 7-4 AC Characteristics,  $V_{CE} = 3 \text{ V}, f = 0.45 \text{ GHz}$

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
<b>Power Gain</b>					dB	
Maximum power gain	$G_{ms}$	—	31.5	—		$I_C = 13 \text{ mA}$
Transducer gain	$ S_{21} ^2$	—	28	—		$I_C = 13 \text{ mA}$
<b>Minimum Noise Figure</b>					dB	
Minimum noise figure	$NF_{min}$	—	0.45	—		$I_C = 4 \text{ mA}$
Associated gain	$G_{ass}$	—	25.5	—		$I_C = 4 \text{ mA}$
<b>Linearity</b>					dBm	
1 dB compression point at output	$OP_{1dB}$	—	5.5	—		$Z_S = Z_L = 50 \Omega$
3rd order intercept point at output	$OIP_3$	—	19.5	—		$I_C = 13 \text{ mA}$

## Electrical Characteristics

**Table 7-5 AC Characteristics,  $V_{CE} = 3\text{ V}, f = 0.9\text{ GHz}$** 

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
<b>Power Gain</b>						
Maximum power gain	$G_{ms}$	—	29	—	dB	$I_C = 13\text{ mA}$
Transducer gain	$ S_{21} ^2$	—	27	—		$I_C = 13\text{ mA}$
<b>Minimum Noise Figure</b>						
Minimum noise figure	$NF_{min}$	—	0.45	—	dB	$I_C = 4\text{ mA}$
Associated gain	$G_{ass}$	—	24.5	—		$I_C = 4\text{ mA}$
<b>Linearity</b>						
1 dB compression point at output	$OP_{1dB}$	—	5.5	—	dBm	$Z_S = Z_L = 50\Omega$
3rd order intercept point at output	$OIP_3$	—	20	—		$I_C = 13\text{ mA}$
						$I_C = 13\text{ mA}$

**Table 7-6 AC Characteristics,  $V_{CE} = 3\text{ V}, f = 1.5\text{ GHz}$** 

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
<b>Power Gain</b>						
Maximum power gain	$G_{ms}$	—	26.5	—	dB	$I_C = 13\text{ mA}$
Transducer gain	$ S_{21} ^2$	—	25.5	—		$I_C = 13\text{ mA}$
<b>Minimum Noise Figure</b>						
Minimum noise figure	$NF_{min}$	—	0.45	—	dB	$I_C = 4\text{ mA}$
Associated gain	$G_{ass}$	—	22.5	—		$I_C = 4\text{ mA}$
<b>Linearity</b>						
1 dB compression point at output	$OP_{1dB}$	—	5.5	—	dBm	$Z_S = Z_L = 50\Omega$
3rd order intercept point at output	$OIP_3$	—	20	—		$I_C = 13\text{ mA}$
						$I_C = 13\text{ mA}$

**Table 7-7 AC Characteristics,  $V_{CE} = 3\text{ V}, f = 1.9\text{ GHz}$** 

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
<b>Power Gain</b>						
Maximum power gain	$G_{ms}$	—	25.5	—	dB	$I_C = 13\text{ mA}$
Transducer gain	$ S_{21} ^2$	—	24	—		$I_C = 13\text{ mA}$
<b>Minimum Noise Figure</b>						
Minimum noise figure	$NF_{min}$	—	0.45	—	dB	$I_C = 4\text{ mA}$
Associated gain	$G_{ass}$	—	21.5	—		$I_C = 4\text{ mA}$
<b>Linearity</b>						
1 dB compression point at output	$OP_{1dB}$	—	5.5	—	dBm	$Z_S = Z_L = 50\Omega$
3rd order intercept point at output	$OIP_3$	—	20.5	—		$I_C = 13\text{ mA}$
						$I_C = 13\text{ mA}$

## Electrical Characteristics

**Table 7-8 AC Characteristics,  $V_{CE} = 3\text{ V}$ ,  $f = 2.4\text{ GHz}$** 

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
<b>Power Gain</b>						
Maximum power gain	$G_{ms}$	—	24.5	—	dB	$I_C = 13\text{ mA}$
Transducer gain	$ S_{21} ^2$	—	23	—		$I_C = 13\text{ mA}$
<b>Minimum Noise Figure</b>						
Minimum noise figure	$NF_{min}$	—	0.5	—	dB	$I_C = 4\text{ mA}$
Associated gain	$G_{ass}$	—	20	—		$I_C = 4\text{ mA}$
<b>Linearity</b>						
1 dB compression point at output	$OP_{1dB}$	—	6	—	dBm	$Z_S = Z_L = 50\Omega$
3rd order intercept point at output	$OIP_3$	—	21	—		$I_C = 13\text{ mA}$
						$I_C = 13\text{ mA}$

**Table 7-9 AC Characteristics,  $V_{CE} = 3\text{ V}$ ,  $f = 3.5\text{ GHz}$** 

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
<b>Power Gain</b>						
Maximum power gain	$G_{ms}$	—	23	—	dB	$I_C = 13\text{ mA}$
Transducer gain	$ S_{21} ^2$	—	20	—		$I_C = 13\text{ mA}$
<b>Minimum Noise Figure</b>						
Minimum noise figure	$NF_{min}$	—	0.55	—	dB	$I_C = 4\text{ mA}$
Associated gain	$G_{ass}$	—	17	—		$I_C = 4\text{ mA}$
<b>Linearity</b>						
1 dB compression point at output	$OP_{1dB}$	—	6.5	—	dBm	$Z_S = Z_L = 50\Omega$
3rd order intercept point at output	$OIP_3$	—	22.5	—		$I_C = 13\text{ mA}$
						$I_C = 13\text{ mA}$

**Table 7-10 AC Characteristics,  $V_{CE} = 3\text{ V}$ ,  $f = 5.5\text{ GHz}$** 

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
<b>Power Gain</b>						
Maximum power gain	$G_{ms}$	—	21	—	dB	$I_C = 13\text{ mA}$
Transducer gain	$ S_{21} ^2$	—	16.5	—		$I_C = 13\text{ mA}$
<b>Minimum Noise Figure</b>						
Minimum noise figure	$NF_{min}$	—	0.65	—	dB	$I_C = 4\text{ mA}$
Associated gain	$G_{ass}$	—	13.5	—		$I_C = 4\text{ mA}$
<b>Linearity</b>						
1 dB compression point at output	$OP_{1dB}$	—	7.5	—	dBm	$Z_S = Z_L = 50\Omega$
3rd order intercept point at output	$OIP_3$	—	23	—		$I_C = 13\text{ mA}$
						$I_C = 13\text{ mA}$

## Electrical Characteristics

**Table 7-11 AC Characteristics,  $V_{CE} = 3\text{ V}, f = 10\text{ GHz}$** 

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
<b>Power Gain</b>						
Maximum power gain	$G_{ma}$	—	14.5	—	dB	$I_C = 13\text{ mA}$
Transducer gain	$ S_{21} ^2$	—	11	—		$I_C = 13\text{ mA}$
<b>Minimum Noise Figure</b>						
Minimum noise figure	$NF_{min}$	—	1	—	dB	$I_C = 4\text{ mA}$
Associated gain	$G_{ass}$	—	8.5	—		$I_C = 4\text{ mA}$
<b>Linearity</b>						
1 dB compression point at output	$OP_{1dB}$	—	7.5	—	dBm	$Z_S = Z_L = 50\Omega$
3rd order intercept point at output	$OIP_3$	—	22.5	—		$I_C = 13\text{ mA}$
						$I_C = 13\text{ mA}$

**Table 7-12 AC Characteristics,  $V_{CE} = 3\text{ V}, f = 12\text{ GHz}$** 

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
<b>Power Gain</b>						
Maximum power gain	$G_{ma}$	—	12	—	dB	$I_C = 13\text{ mA}$
Transducer gain	$ S_{21} ^2$	—	9	—		$I_C = 13\text{ mA}$
<b>Minimum Noise Figure</b>						
Minimum noise figure	$NF_{min}$	—	1.1	—	dB	$I_C = 4\text{ mA}$
Associated gain	$G_{ass}$	—	8	—		$I_C = 4\text{ mA}$
<b>Linearity</b>						
1 dB compression point at output	$OP_{1dB}$	—	6.5	—	dBm	$Z_S = Z_L = 50\Omega$
3rd order intercept point at output	$OIP_3$	—	18.5	—		$I_C = 13\text{ mA}$
						$I_C = 13\text{ mA}$

Note:  $OIP_3$  value depends on termination of all intermodulation frequency components. Termination used for this measurement is  $50\Omega$  from  $0.2\text{ MHz}$  to  $12\text{ GHz}$ .

## 7.4 Characteristic DC Diagrams

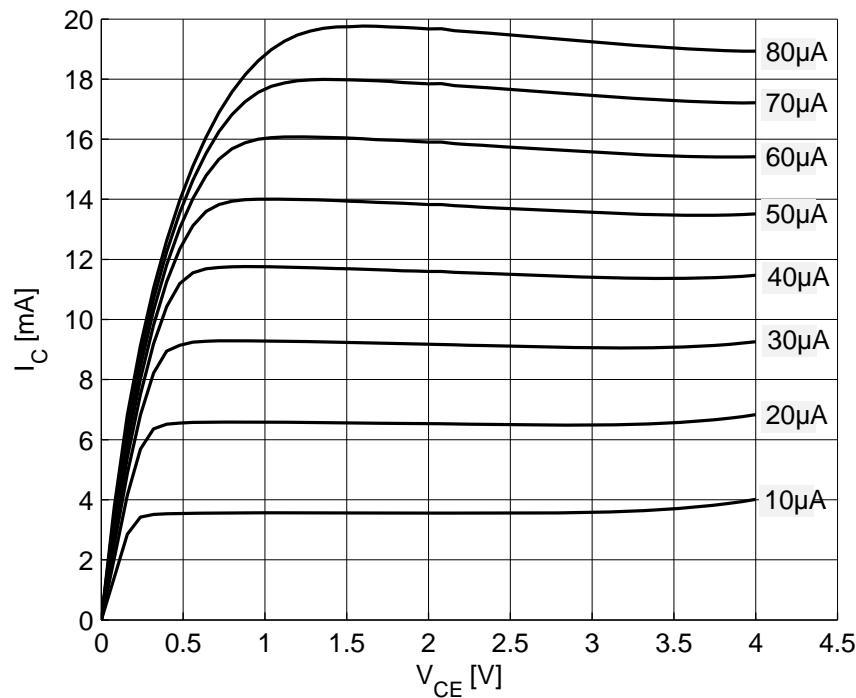


Figure 7-2 Collector Current vs. Collector Emitter Voltage  $I_C = f(V_{CE})$ ,  $I_B$  = Parameter in  $\mu A$

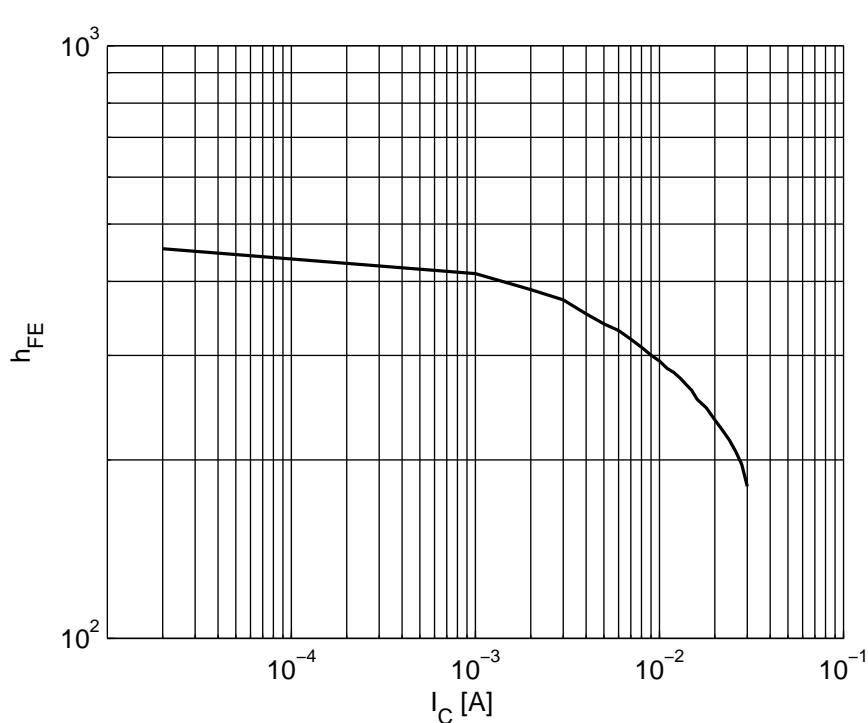
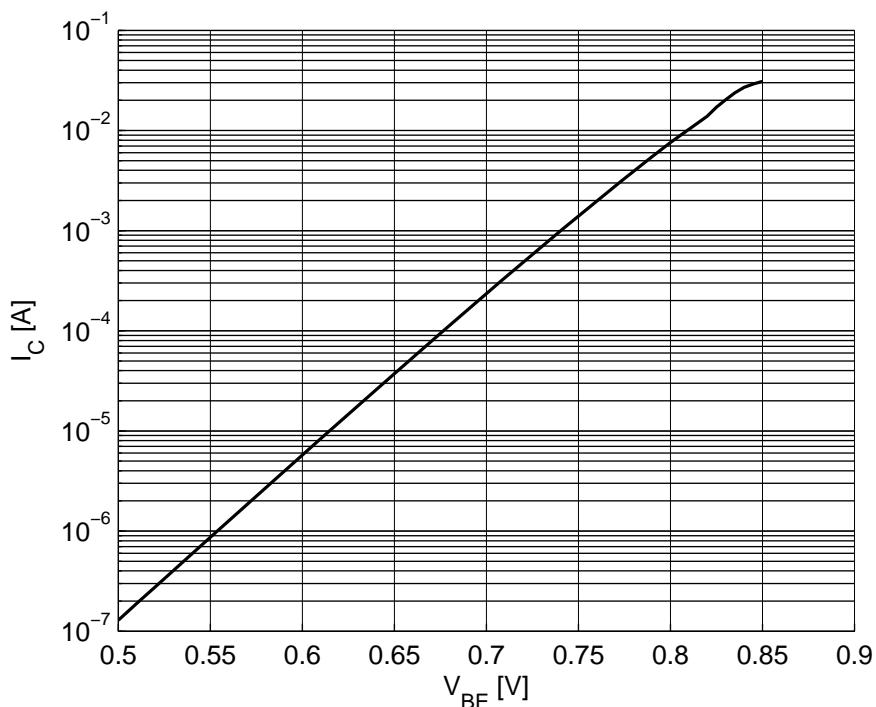
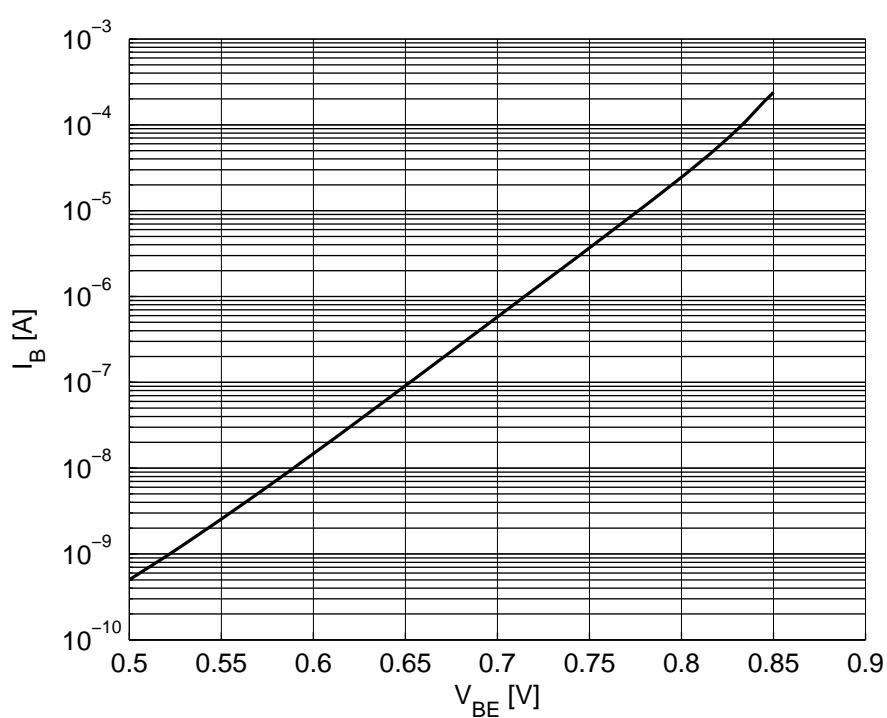


Figure 7-3 DC Current Gain  $h_{FE} = f(I_C)$ ,  $V_{CE} = 3$  V

**Electrical Characteristics**


**Figure 7-4** Collector Current vs. Base Emitter Forward Voltage  $I_C = f(V_{BE})$ ,  $V_{CE} = 2\text{ V}$



**Figure 7-5** Base Current vs. Base Emitter Forward Voltage  $I_B = f(V_{BE})$ ,  $V_{CE} = 2\text{ V}$

## Electrical Characteristics

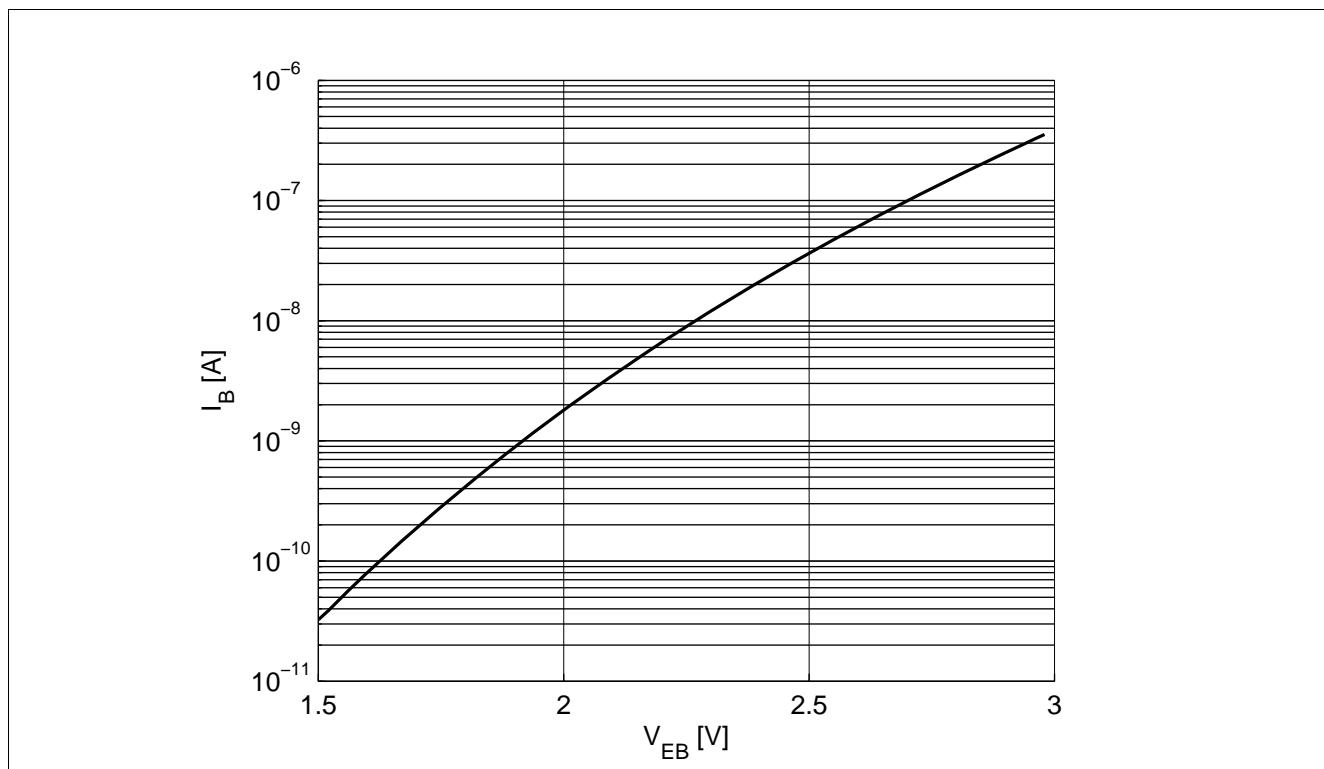


Figure 7-6 Base Current vs. Base Emitter Reverse Voltage  $I_B = f(V_{EB})$ ,  $V_{CE} = 2$  V

## Electrical Characteristics

## 7.5 Characteristic AC Diagrams

Measurement setup is a test fixture with Bias-T's in a  $50\ \Omega$  system,  $T_A = 25\text{ }^\circ\text{C}$ .

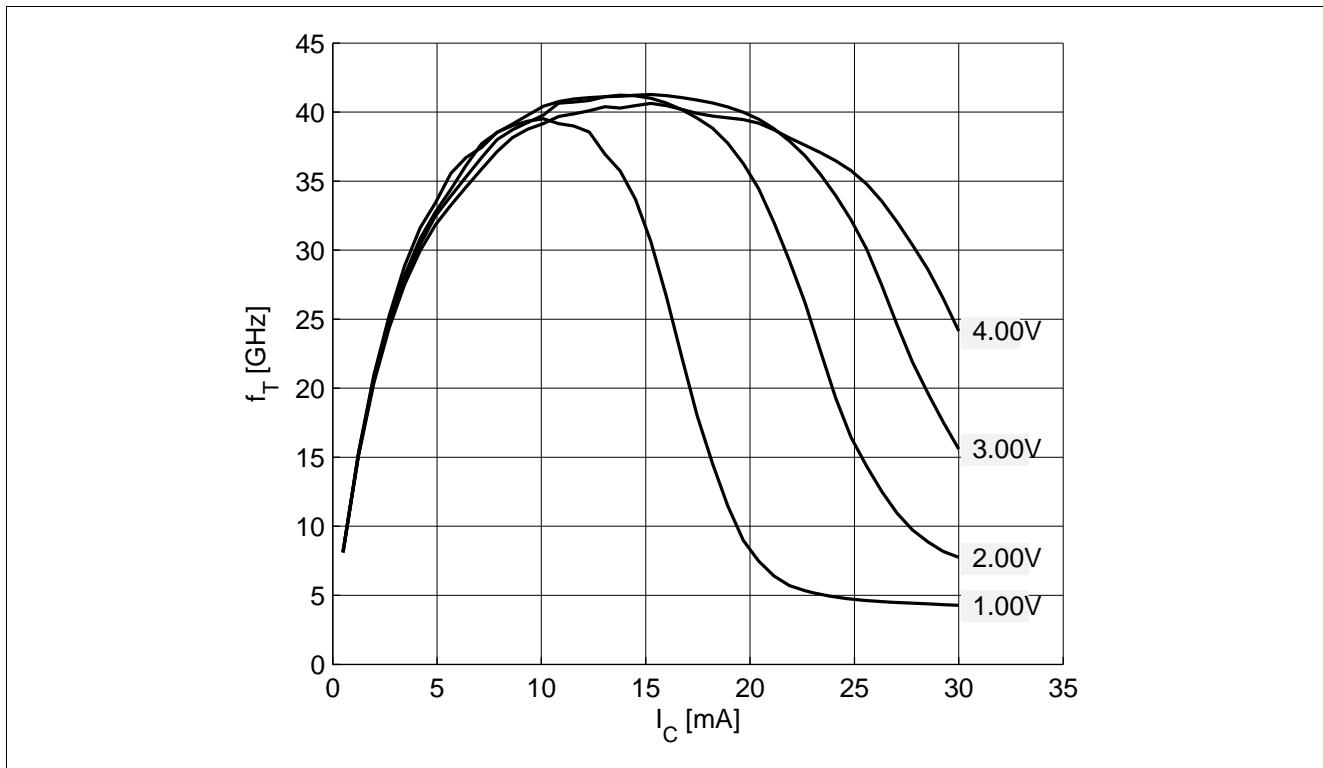


Figure 7-7 Transition Frequency  $f_T = f(I_C)$ ,  $f = 1\text{ GHz}$ ,  $V_{CE}$  = Parameter in V

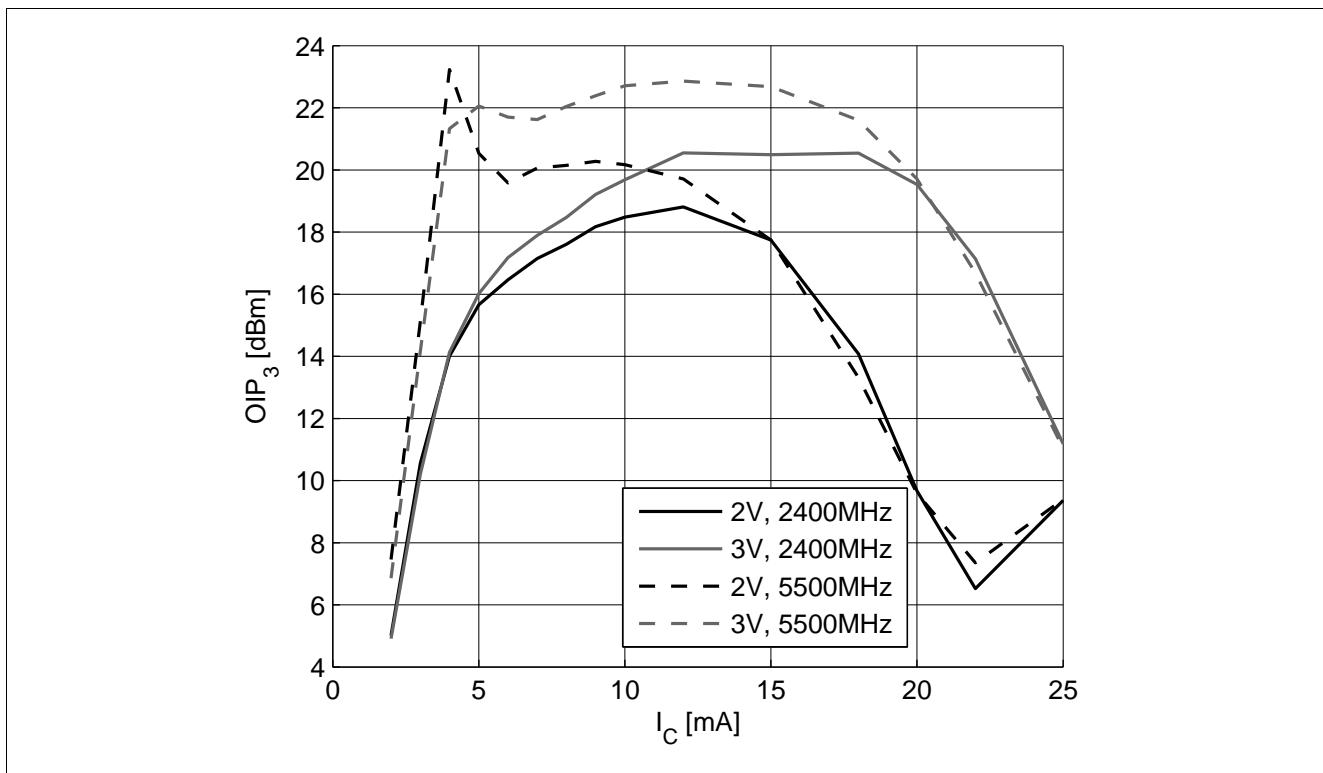
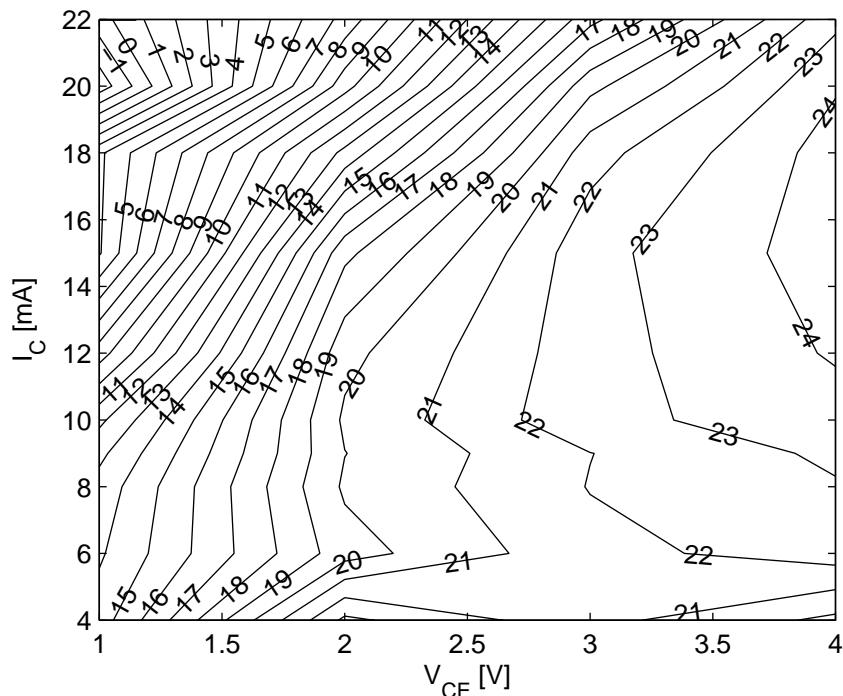
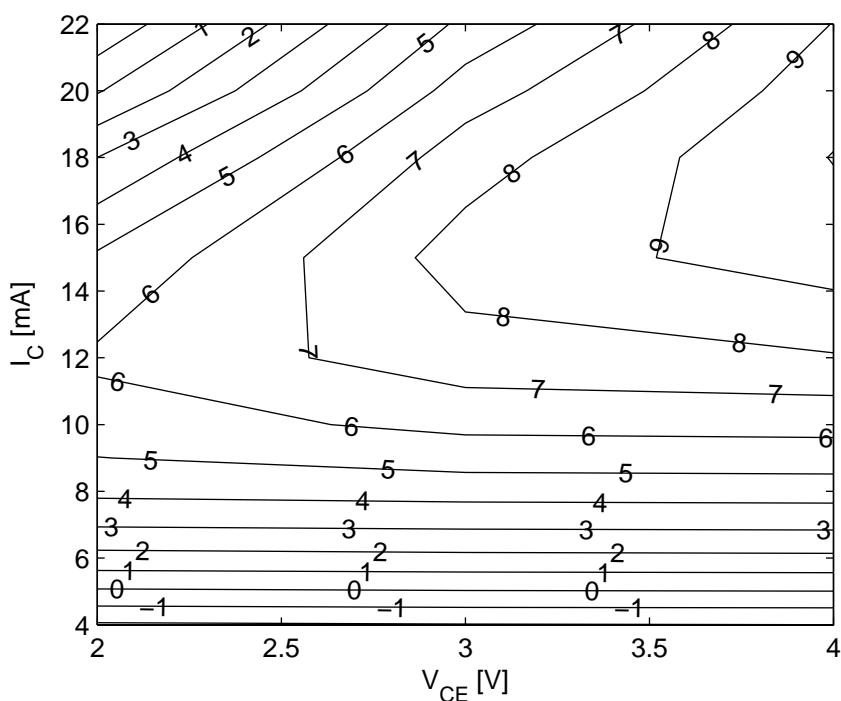


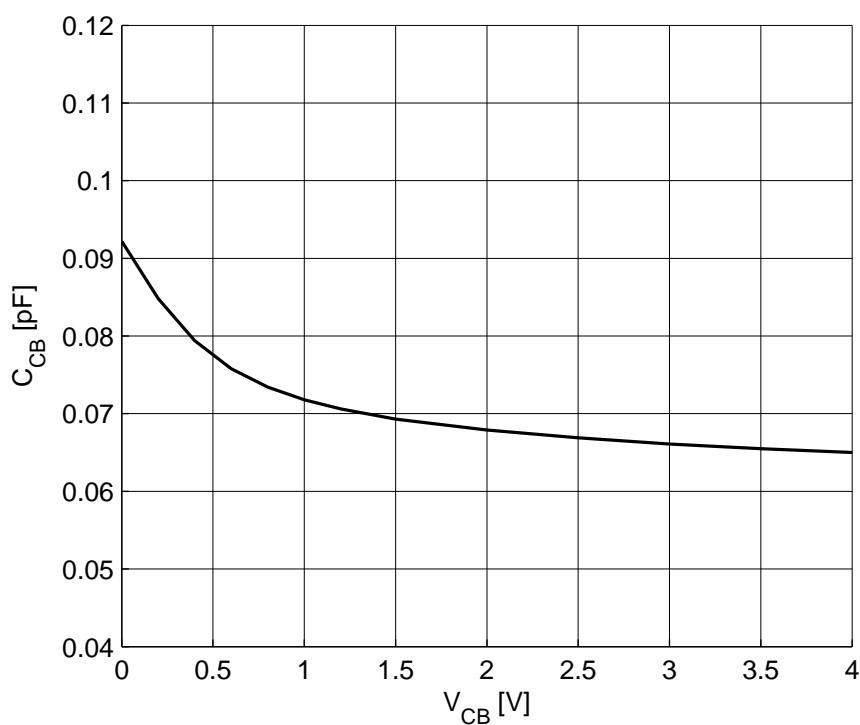
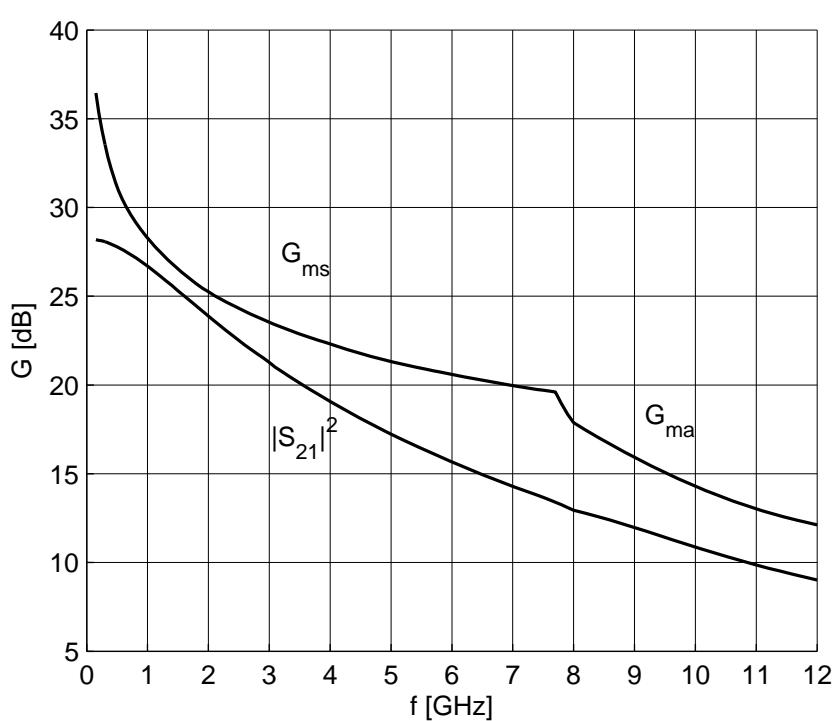
Figure 7-8 3rd Order Intercept Point at Output  $OIP_3 = f(I_C)$ ,  $Z_S = Z_L = 50\ \Omega$ ,  $V_{CE}, f$  = Parameters

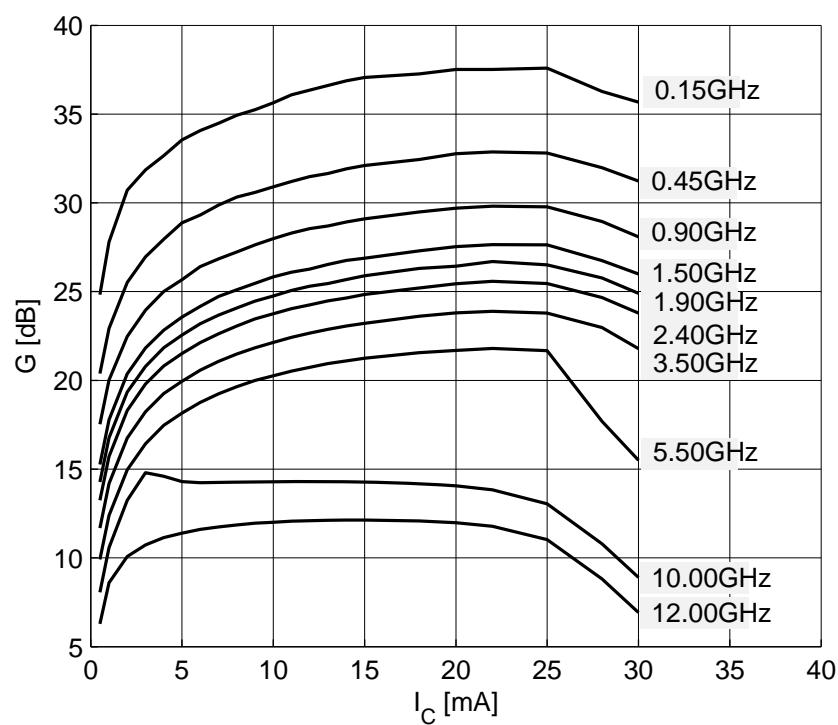
**Electrical Characteristics**


**Figure 7-9 3rd Order Intercept Point at Output  $OIP_3$  [dBm] =  $f(I_C, V_{CE})$ ,  $Z_S = Z_L = 50 \Omega$ ,  $f = 5.5$  GHz**

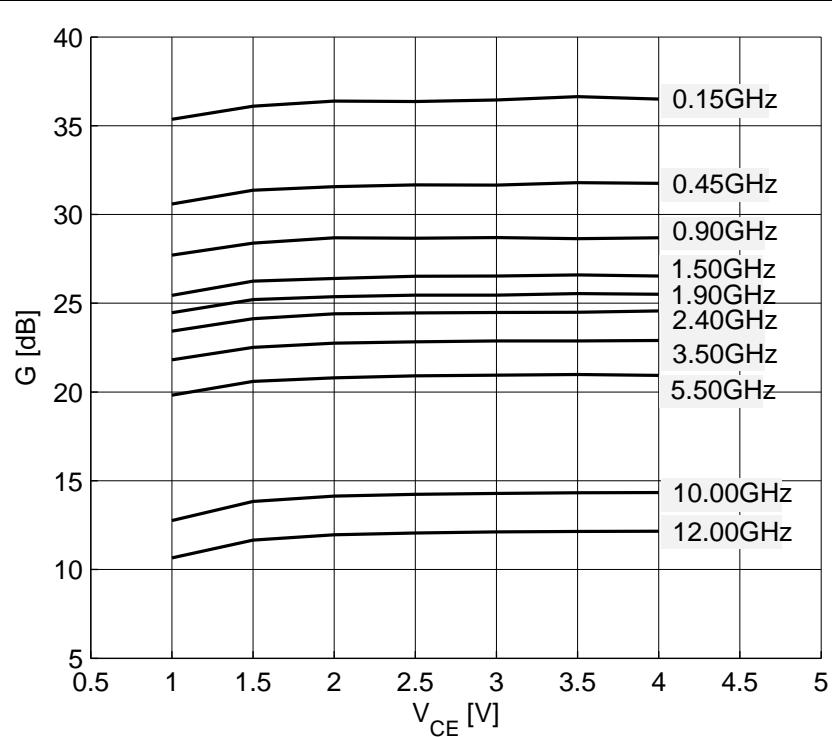


**Figure 7-10 Compression Point at Output  $OP_{1dB}$  [dBm] =  $f(I_C, V_{CE})$ ,  $Z_S = Z_L = 50 \Omega$ ,  $f = 5.5$  GHz**

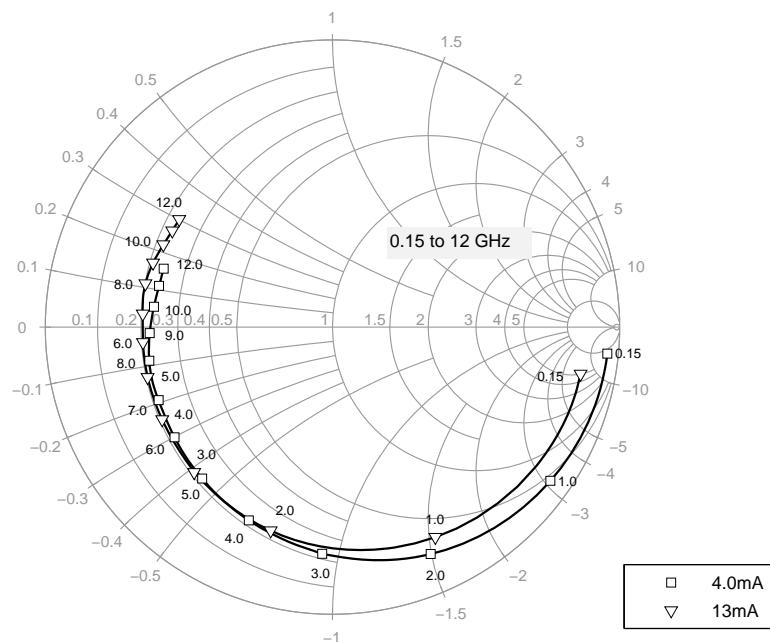
**Electrical Characteristics**

**Figure 7-11 Collector Base Capacitance  $C_{CB} = f(V_{CB})$ ,  $f = 1$  MHz**

**Figure 7-12 Gain  $G_{ma}, G_{ms}, |S_{21}|^2 = f(f)$ ,  $V_{CE} = 3$  V,  $I_C = 13$  mA**

**Electrical Characteristics**


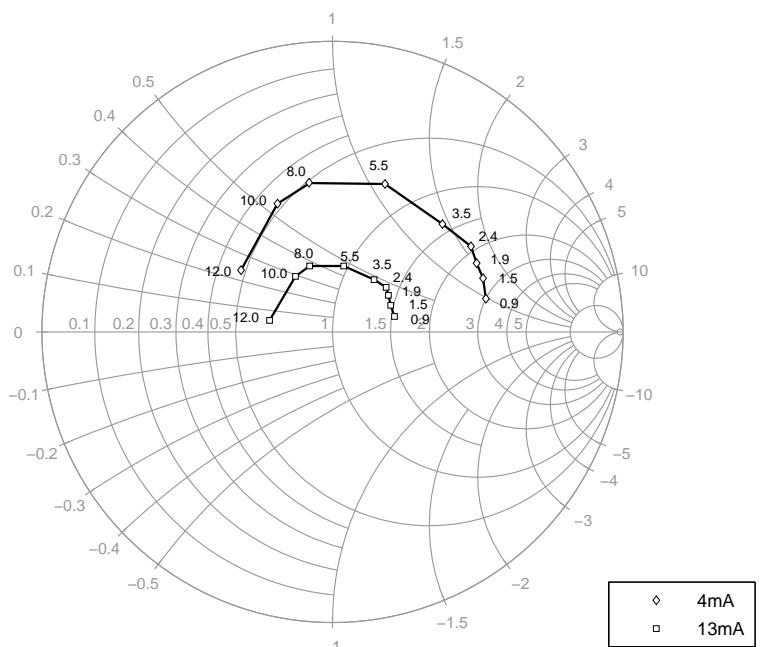
**Figure 7-13 Maximum Power Gain  $G_{\max} = f(I_C)$ ,  $V_{CE}, f = 3 \text{ V}$ ,  $f = \text{Parameter in GHz}$**



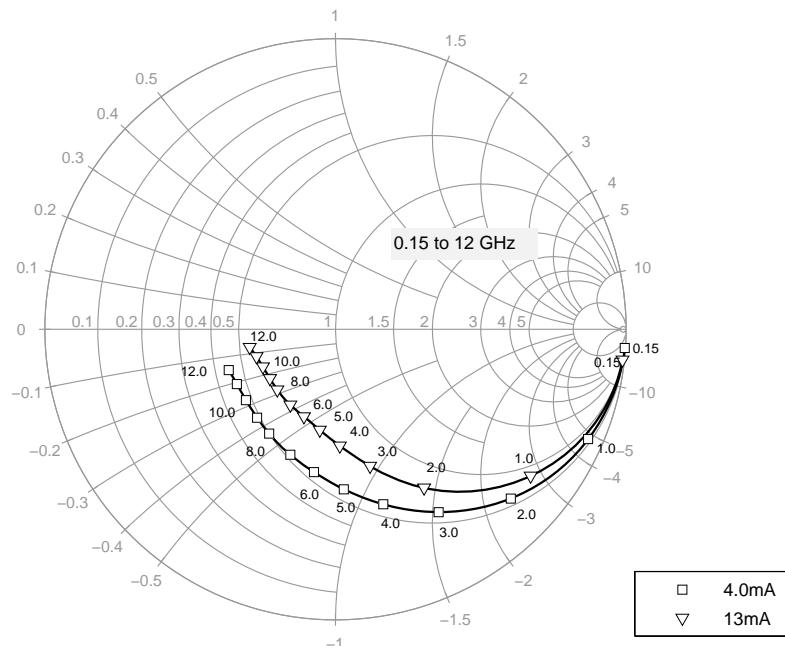
**Figure 7-14 Maximum Power Gain  $G_{\max} = f(V_{CE})$ ,  $I_C = 13 \text{ mA}$ ,  $f = \text{Parameter in GHz}$**

**Electrical Characteristics**


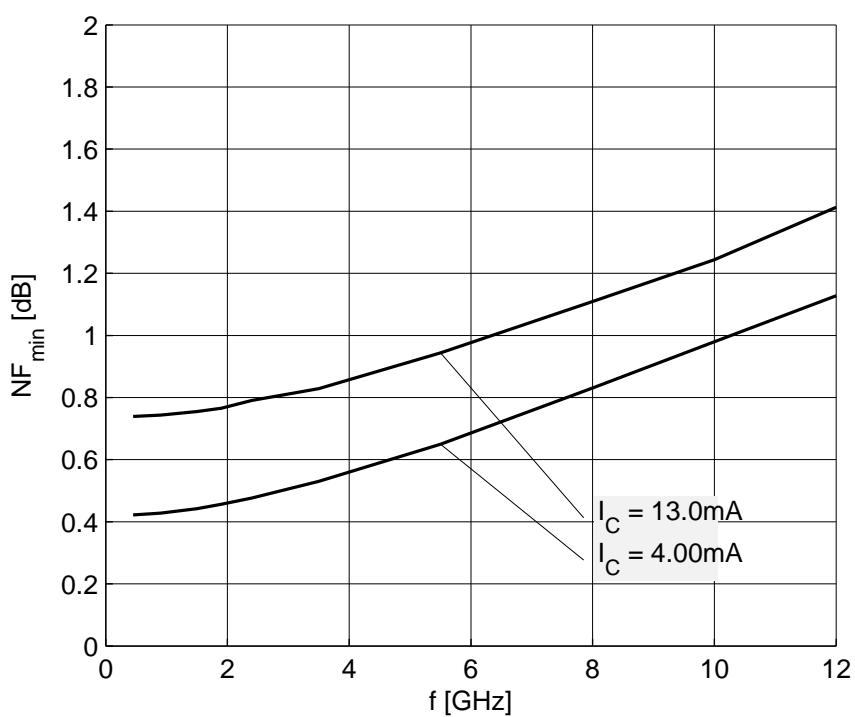
**Figure 7-15 Input Matching  $S_{11} = f(f)$ ,  $V_{CE} = 3 \text{ V}$ ,  $I_C = 4 / 13 \text{ mA}$**



**Figure 7-16 Source Impedance for Minimum Noise Figure  $Z_{\text{opt}} = f(f)$ ,  $V_{CE} = 3 \text{ V}$ ,  $I_C = 4 / 13 \text{ mA}$**

**Electrical Characteristics**


**Figure 7-17 Output Matching  $S_{22} = f(f)$ ,  $V_{CE} = 3 \text{ V}$ ,  $I_C = 4 / 13 \text{ mA}$**



**Figure 7-18 Noise Figure  $NF_{\min} = f(f)$ ,  $V_{CE} = 3 \text{ V}$ ,  $I_C = 4 / 13 \text{ mA}$ ,  $Z_S = Z_{\text{opt}}$**

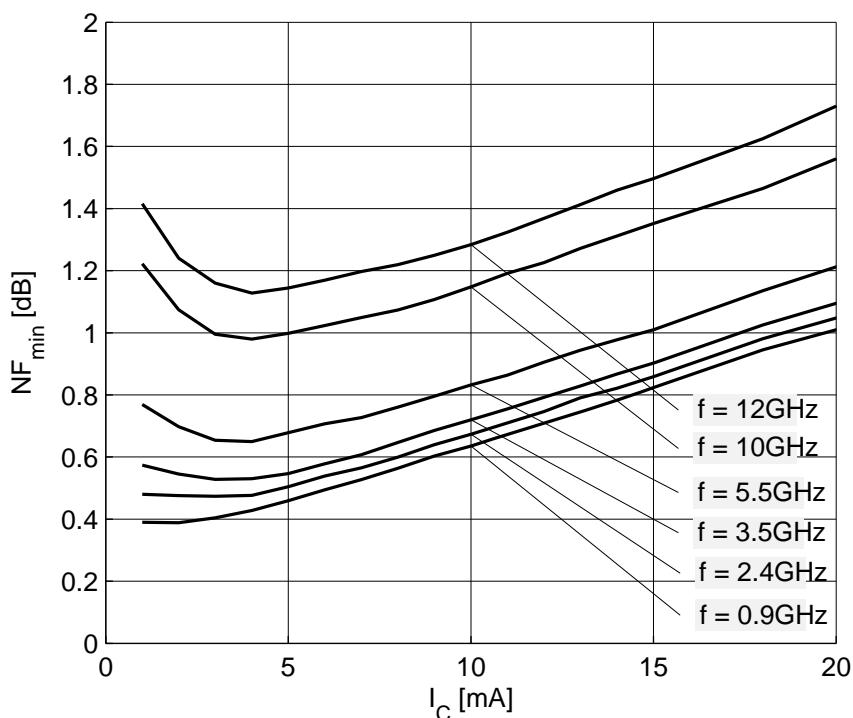
**Electrical Characteristics**


Figure 7-19 Noise Figure  $NF_{min} = f(I_C)$ ,  $V_{CE} = 3\text{ V}$ ,  $Z_S = Z_{opt}$ ,  $f = \text{Parameter in GHz}$

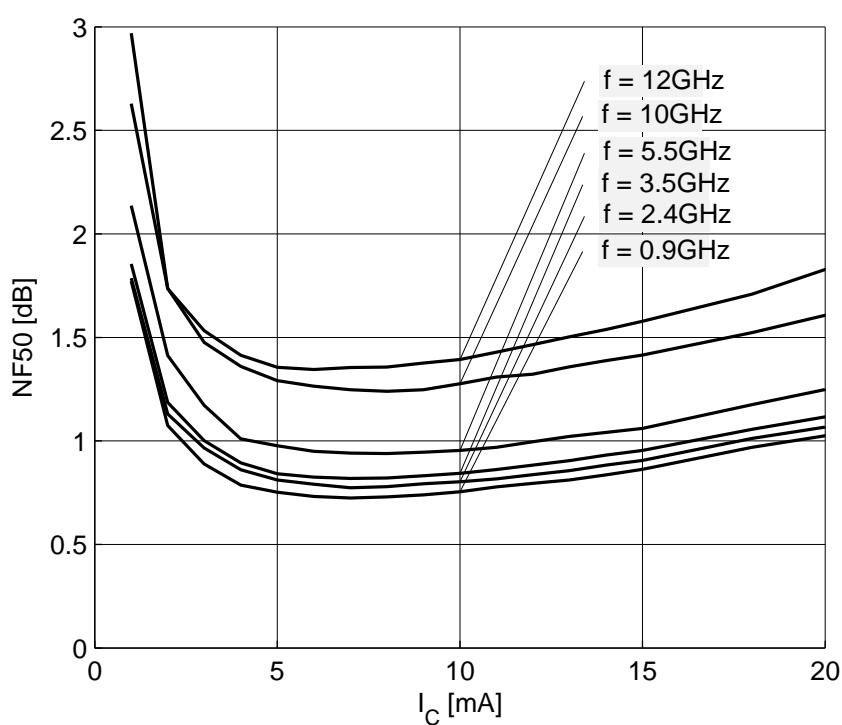


Figure 7-20 Noise Figure  $NF_{50} = f(I_C)$ ,  $V_{CE} = 3\text{ V}$ ,  $Z_S = 50\Omega$ ,  $f = \text{Parameter in GHz}$

Note: The curves shown in this chapter have been generated using typical devices but shall not be considered as a guarantee that all devices have identical characteristic curves.

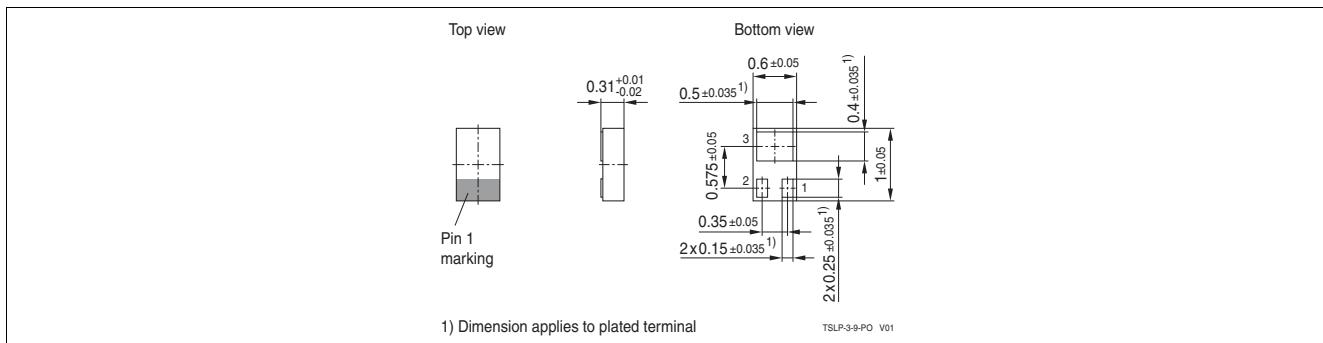
## 8 Simulation Data

For the SPICE Gummel Poon (GP) model as well as for the S-parameters (including noise parameters) please refer to our internet website: [www.infineon.com/rf.models](http://www.infineon.com/rf.models). Please consult our website and download the latest versions before actually starting your design.

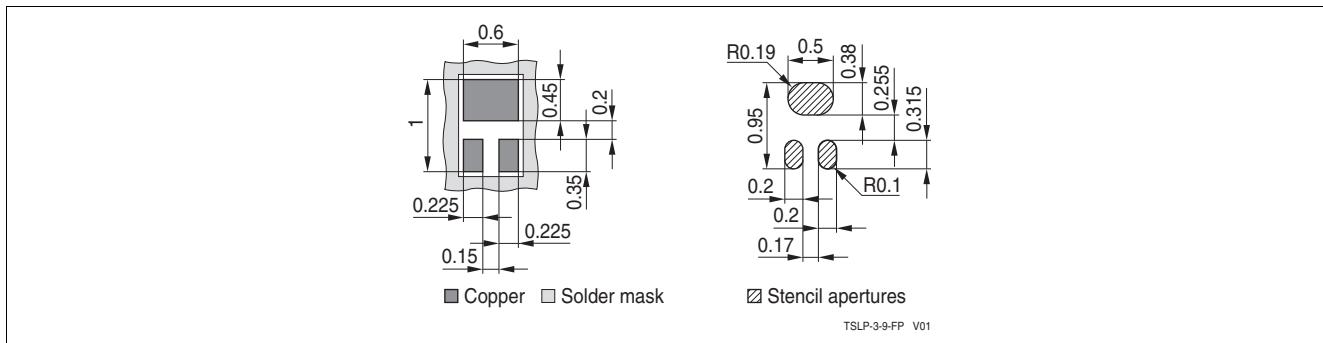
You find the BFR720L3RH SPICE GP model in the internet in MWO- and ADS-format, which you can import into these circuit simulation tools very quickly and conveniently. The model already contains the package parasitics and is ready to use for DC- and high frequency simulations. The terminals of the model circuit correspond to the pin configuration of the device.

The model parameters have been extracted and verified up to 10 GHz using typical devices. The BFR720L3RH SPICE GP model reflects the typical DC- and RF-performance within the limitations which are given by the SPICE GP model itself. Besides the DC characteristics all S-parameters in magnitude and phase, as well as noise figure (including optimum source impedance, equivalent noise resistance and flicker noise) and intermodulation have been extracted.

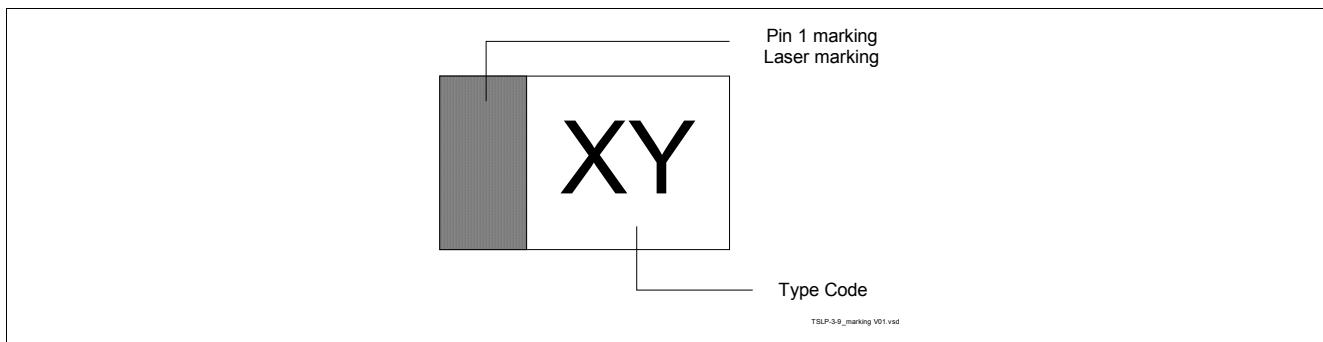
## 9 Package Information TSLP-3-9



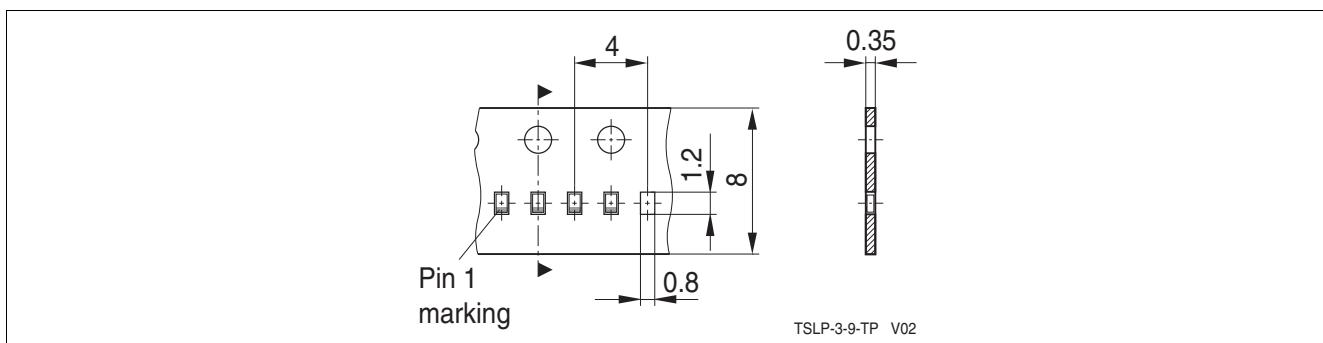
**Figure 9-1 Package Outline of TSLP-3-9**



**Figure 9-2 Footprint of TSLP-3-9**



**Figure 9-3 Marking Layout of TSLP-3-9**



**Figure 9-4 Tape of TSLP-3-9**

[www.infineon.com](http://www.infineon.com)